

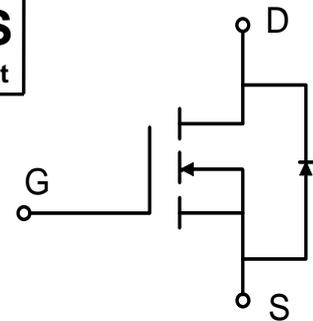
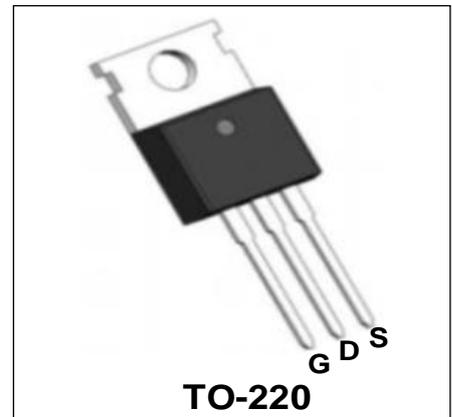
150V N-Channel Enhancement Mode Power MOSFET

Description

WMK161N15T2 uses advanced power trench technology that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

Features

- $V_{DS} = 150V$, $I_D = 161A$
 $R_{DS(on)} < 6m\Omega @ V_{GS} = 10V$
- High Speed Power Switching
- Low $R_{DS(ON)}$
- Low Gate Charge
- 100% EAS Guaranteed



Applications

- Synchronous Rectification in SMPS
- Hard Switching and High Speed Circuit
- UPS

Absolute Maximum Ratings

Parameter		Symbol	Value	Unit
Drain-Source voltage		V_{DS}	150	V
Gate-Source voltage		V_{GS}	± 20	V
Continuous Drain Current ¹	$T_C=25^\circ C$	I_D	161	A
	$T_C=100^\circ C$		115	
Pulsed Drain Current ²		I_{DM}	540	A
Single Pulse Avalanche Energy ³		EAS	720	mJ
Avalanche Current		I_{AS}	60	A
Total Power Dissipation ⁴	$T_C=25^\circ C$	P_D	365	W
Operating Junction and Storage Temperature Range		T_J, T_{STG}	-55 to 175	$^\circ C$

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal Resistance from Junction-to-Ambient ¹	$R_{\theta JA}$	61	$^\circ C/W$
Thermal Resistance from Junction-to-Case ¹	$R_{\theta JC}$	0.41	$^\circ C/W$

Electrical Characteristics $T_c = 25^\circ\text{C}$, unless otherwise noted

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit	
Static Characteristics							
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	150	-	-	V	
Gate-body Leakage current	I_{GSS}	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	± 100	nA	
Zero Gate Voltage Drain Current	$T_J=25^\circ\text{C}$	I_{DSS}	$V_{DS} = 150V, V_{GS} = 0V$	-	-	1	μA
	$T_J=100^\circ\text{C}$			-	-	100	
Gate-Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	2	3	4	V	
Drain-Source on-Resistance ²	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 20A$	-	5.4	6	m Ω	
Forward Transconductance ²	g_{fs}	$V_{DS}=5V, I_D=20A$	-	80	-	S	
Dynamic Characteristics							
Input Capacitance	C_{iss}	$V_{DS} = 75V, V_{GS} = 0V,$ $f = 1\text{MHz}$	-	6220	-	pF	
Output Capacitance	C_{oss}		-	480	-		
Reverse Transfer Capacitance	C_{rss}		-	11	-		
Switching Characteristics							
Gate Resistance	R_g	$V_{GS} = 0V, V_{DS} = 0V$ $f = 1\text{MHz}$	-	1.2	-	Ω	
Total Gate Charge	Q_g	$V_{GS} = 10V, V_{DD} = 75V,$ $I_D = 20A$	-	78	-	nC	
Gate-Source Charge	Q_{gs}		-	29	-		
Gate-Drain Charge	Q_{gd}		-	11	-		
Turn-on Delay Time	$t_{d(on)}$	$V_{GS} = 10V, V_{DD} = 75V,$ $R_G = 10\Omega, I_D = 20A$	-	26	-	nS	
Rise Time	t_r		-	19	-		
Turn-off Delay Time	$t_{d(off)}$		-	39	-		
Fall Time	t_f		-	15	-		
Drain-source body diode Characteristics							
Diode Forward Voltage ²	V_{SD}	$I_S = 20A, V_{GS} = 0V$	-	-	1.2	V	
Continuous Source Current ^{1,5}	I_S	$V_G=V_D=0V$, Force Current	-	-	161	A	
Body Diode Reverse Recovery Time	t_{rr}	$V_R = 75V, I_F = 20A,$ $di/dt=100A/\mu s$	-	79	-	nS	
Body Diode Reverse Recovery Charge	Q_{rr}		-	158	-	nC	

Notes:

- The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- The data tested by pulsed , pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$
- The EAS data shows Max. rating . The test condition is $V_{DD}=25V, V_{GS}=10V, L=0.4mH, I_{AS}=60A$
- The power dissipation is limited by 175°C junction temperature
- The data is theoretically the same as I_D and I_{DM} , in real applications , should be limited by total power dissipation.

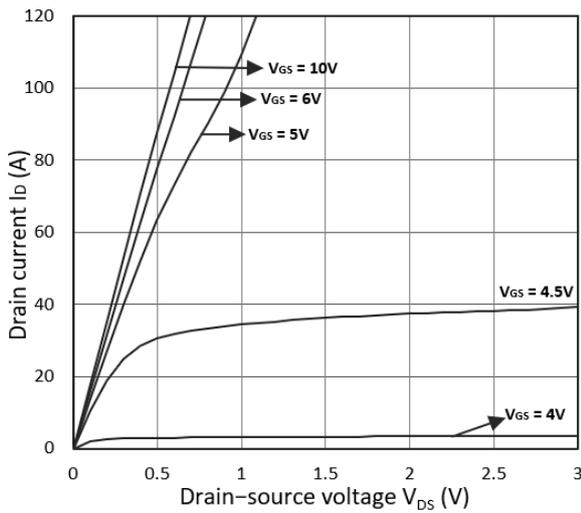


Figure 1. Output Characteristics

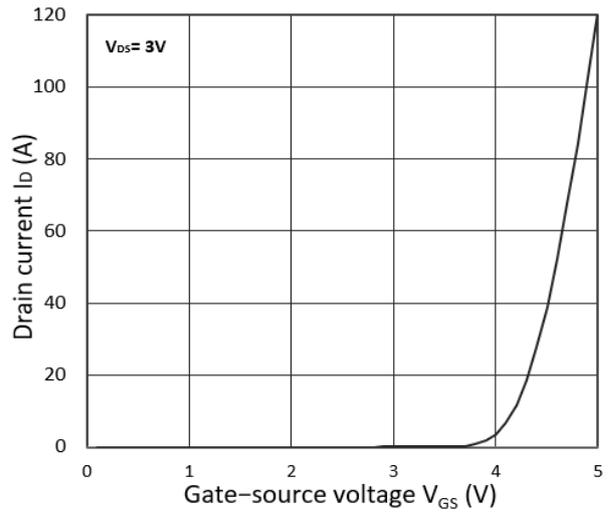


Figure 2. Transfer Characteristics

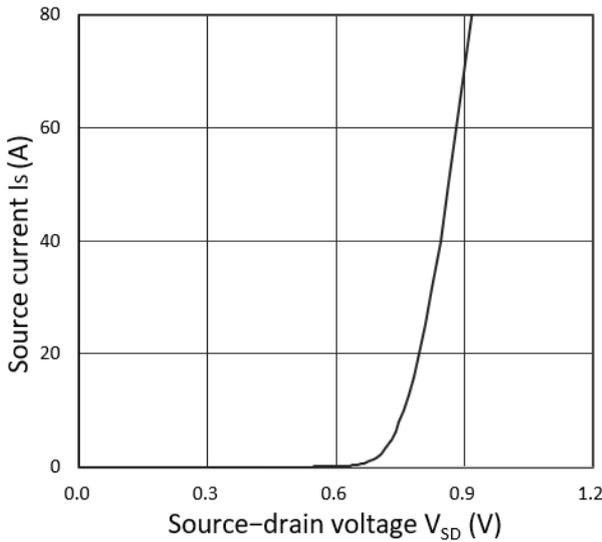


Figure 3. Forward Characteristics of Reverse

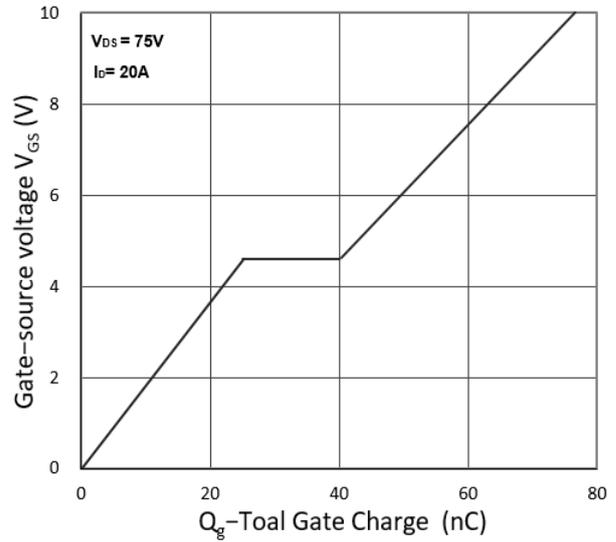


Figure 4. Gate Charge Characteristics

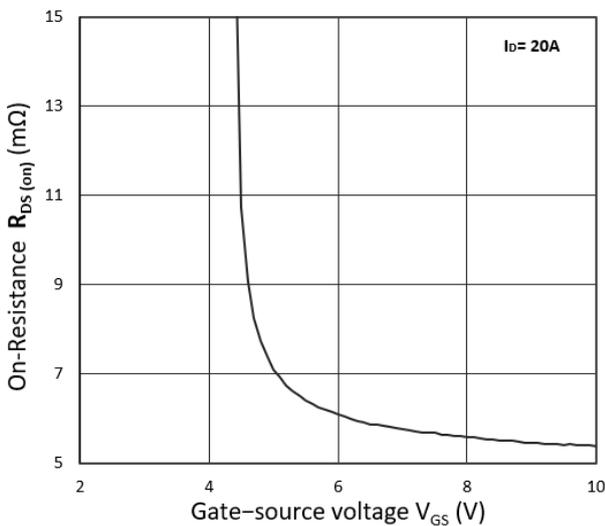


Figure 5. $R_{DS(ON)}$ vs. V_{GS}

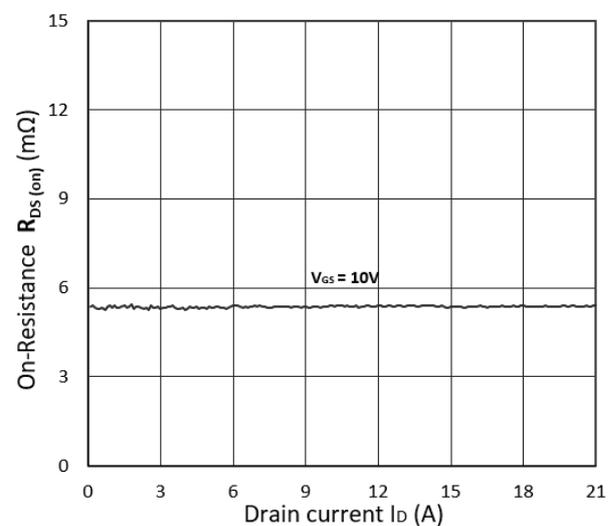


Figure 6. $R_{DS(ON)}$ vs. I_D

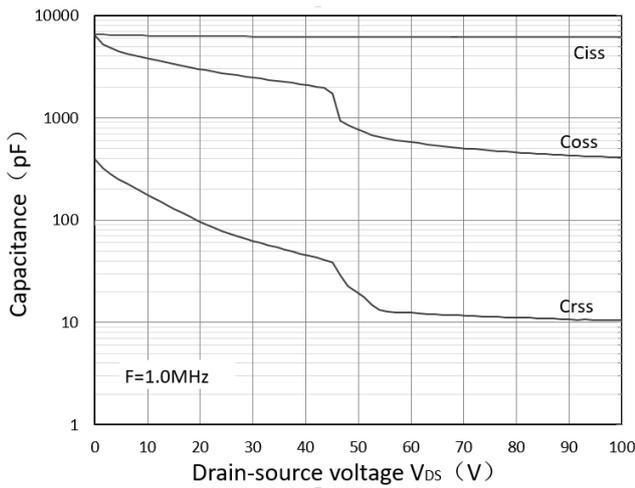


Figure 7. Capacitance Characteristics

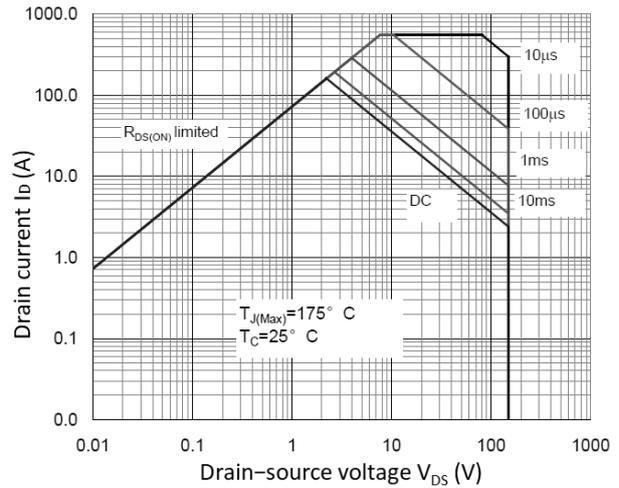


Figure 8. Safe Operating Area

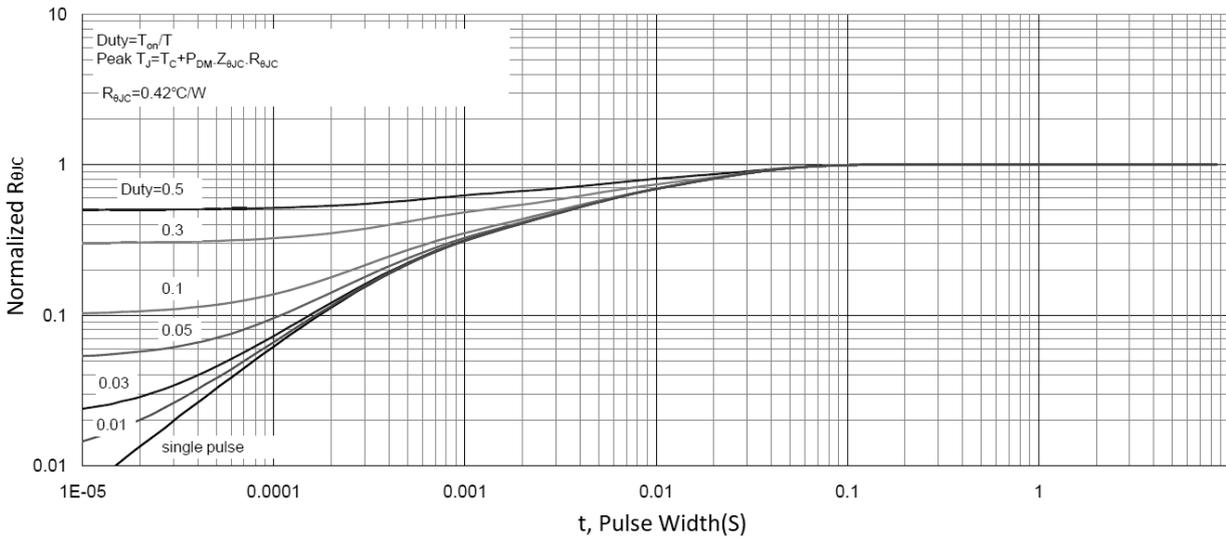


Figure 9. Normalized Maximum Transient Thermal Impedance

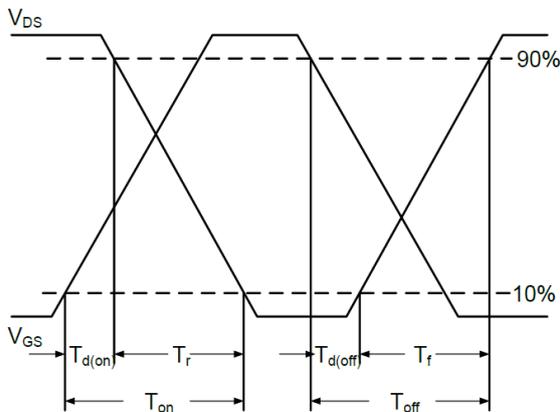


Figure 10. Switching Time Waveform

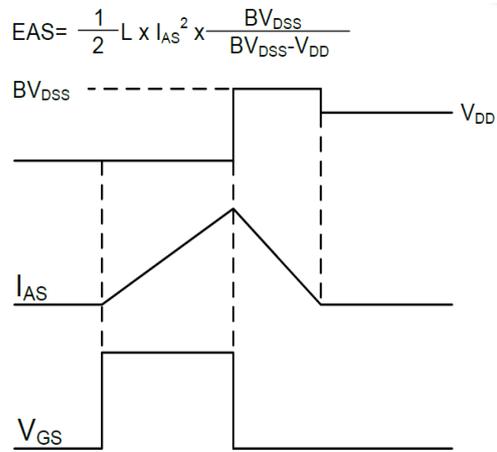
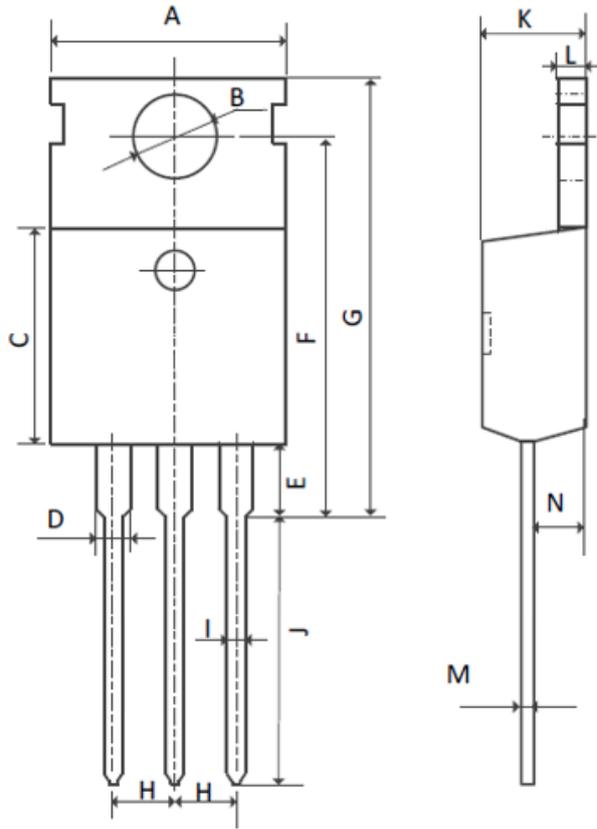


Figure 11. Unclamped Inductive Switching Waveform

$$EAS = \frac{1}{2} L \times I_{AS}^2 \times \frac{BV_{DSS}}{BV_{DSS} - V_{DD}}$$

Mechanical Dimensions for TO-220

COMMON DIMENSIONS

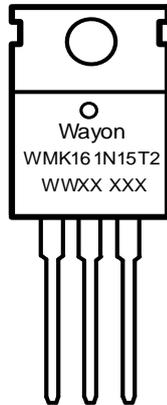


SYMBOL	MM	
	MIN	MAX
A	9.70	10.30
B	3.40	3.80
C	8.80	9.40
D	1.17	1.47
E	2.60	3.40
F	15.10	16.70
G	19.55MAX	
H	2.54REF	
I	0.70	0.95
J	9.35	11.00
K	4.30	4.77
L	1.20	1.45
M	0.40	0.65
N	2.20	2.60

Ordering Information

Part	Package	Marking	Packing method
WMK161N15T2	TO-220	WMK161N15T2	Tube

Marking Information



WMK161N15T2= Device code
 WWXX XXX= Date code

Contact Information

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